TOSHIBA Photocoupler Photorelay

TLX9160T

Battery Control in Automotive Equipment Fuel Battery Control in Automotive Equipment Application for Electrical Vehicle

The Toshiba TLX9160T consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SO16L-T package.

This coupler uses high voltage MOSFET between output terminals.

It adequate for the automotive control applications with a battery voltage of 1000V or less in an environment with a pollution degree 2 since the creepage distance on the detector side is 5mm or more.

• Normally open (1-Form-A) device

• Peak off-state voltage: 1500 V (min)

Trigger LED current: 3 mA (max)

• On-state current: 50 mA (max)

On-state resistance: 250 Ω (max)(@ t < 1 s)

Isolation voltage: 5000 Vrms (min)

• Clearance distance: 8mm (min)

· Creepage distance: 8mm (min)

• Insulation thickness: 0.4mm (min)

Outer resin: CTI>600AEC-Q101 qualified

Unit: mm

10.3±0.2

12 3 4 5 6 7 8 0.38±0.1 ⊕ Ø0.1Ø AB

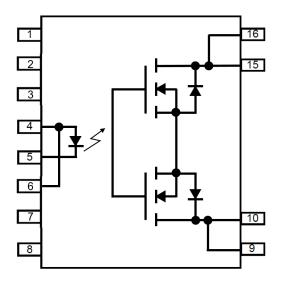
JEDEC —

JEITA —

TOSHIBA 11-10N1A

Weight: 0.42 g (typ.)

Pin Configuration (top view)



- 1: NC
- 2: NC
- 3: NC
- 4: Anode 5: Cathode
- 6: Anode
- 0. Allo
- 7: NC
- 8: NC 9: Drain
- 10: Drain
- 15: Drain
- 16: Drain



Absolute Maximum Rating (Unless otherwise specified, Ta = 25°C) (Note)

Characteristics			Symbol	Rating	Unit
	Forward current	lF	30	mA	
	Forward current derating (Ta ≥ 100	ΔIF/°C	-0.8	mA/°C	
LED	Reverse voltage	VR	5	V	
LED	Input Power Dissipation		PD	50	mW
	Input Power Dissipation Derating (Ta ≥ 100 °C)	ΔPD/°C	-1.3	mW/°C
	Junction temperature	Tj	135	°C	
		Ta = 25 °C		50	mA
	On-state current	Ta = 105 °C	ION	20	mA
		Ta = 125 °C		10	mA
	On-state current derating	Ta-45°C	⊿ION/°C	-0.5	mA/°C
	On-state current (Peak) (Note 3)	Ta = 25 °C	lONpk	150	mA
Detector		Ta = 105 °C		60	mA
		Ta = 125 °C		30	mA
	Avalanche current (Note 1)	IAV	0.6	mA	
	Output power dissipation	Po	600	mW	
	Output power dissipation derating	ΔP _O /°C	-7	mW/°C	
	Junction temperature	Tj	135	°C	
Storage temperature			T _{stg}	-55 to 150	°C
Operating temperature			T _{opr}	-40 to 125	°C
Lead solde	Lead soldering temperature (10 s)			260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60%) (Note 2)			BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This product is more sensitive than conventional products to electrostatic discharge (ESD). It is therefore all the more necessary to observe general precautions regarding ESD when handling this component.

Note 1: 1min (max. continuous), Duty cycle=0.1%, 5 time over lifetime.

Note 2: LED pins are shorted together. Detector pins are also shorted together.

Note 3: Exponential curve, pulse width < 1ms, f ≤150Hz

Recommended Operating Conditions (Note)

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	_	1000	V
Forward current	lF	5	10	20	mA
On-state current	Ion	_	_	50	mA
Operating temperature	T _{opr}	-40	_	125	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.



Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
E-mark and the mark	\/-	IF = 10 mA	1.5	1.65	1.8	.,		
LED	Forward voltage	VF	I _F = 10 mA , Ta = -40 to 125 °C	1.4	_	1.95	V	
	Reverse current	IR	V _R = 5 V	_	_	10	μΑ	
(Capacitance	Ст	V = 0 V, f = 1 MHz	_	45	_	pF	
	Output withstand voltage	Voff	IOFF=10uA, Ta=25 °C (Note1)	1500	_	_	٧	
	Off-state current	loff	V _{OFF} = 1000 V , Ta = 25 °C	_	_	100		
Detector			V _{OFF} = 1000 V , Ta = 105 °C	_	_	1000	nA	
			V _{OFF} = 1000 V , Ta = 125 °C			5000		
	Capacitance	Coff	Voff = 0 V, f = 1 MHz		100	_	pF	

Note 1: Reliability test of applying high voltage is demonstrated at 1200V.

Coupled Electrical Characteristics

Characteristics	Symbol	Test Condition N		Тур.	Max	Unit
		ION = 50 mA , Ta=25 °C , t = 10 ms		_	3	
Trigger LED current	l _{FT}	I _{ON} = 20 mA , Ta= -40 to 105 °C, t = 10 ms		_	3	mA
		I _{ON} = 10 mA, Ta= -40 to 125 °C, t = 10 ms		_	3	
Return LED current	IFC	F _F = 100 μA, Ta= -40 to 125 °C, t = 40 ms 0.05		_	_	mA
	Ron	ION = 50 mA, IF = 10 mA,		_	250	Ω
		Ta = 25 °C, t < 1 s				
On-state resistance		ION = 20 mA, I _F = 10 mA,			350	
OII-state resistance		Ta = 105 °C, t < 1 s			330	52
		ION = 10 mA, IF = 10 mA,			400	
		Ta = 125 °C, t <1 s			400	

Isolation Characteristics (Ta = 25°C)

Characteristics Symbol		Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	$V_S = 0 V, f = 1 MHz$ (Note 1)	_	0.9	_	pF
Isolation resistance	Rs	V _S = 1000 V, R.H. ≤ 60 % (Note 1)	5×10^{10}	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s (Note 1)	5000	_	_	Vrms

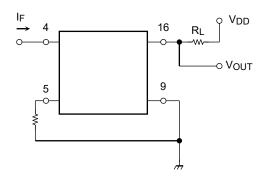
Note 1: Device considered a two terminal device: Pins 1 to 8 shorted together, and pins 9, 10, 15 and 16 shorted together.

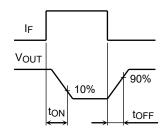


Switching Characteristics

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	I _F = 10 mA,	Ta=25 °C	_	_	1	
Turn-off time	toff	$R_L = 20 \text{ k}\Omega$,	1a-25 C	_	_	1	ms
Turn-on time	ton	V _{DD} = 40 V	Ta=-40 to 125 °C	_	_	1	ma
Turn-off time	toff	(Note 1)	1a40 t0 125 C	_	_	1	ms

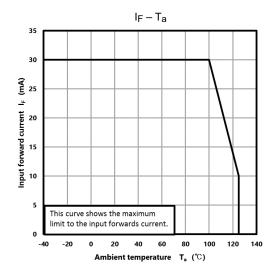
Note 1: Switching time test circuit

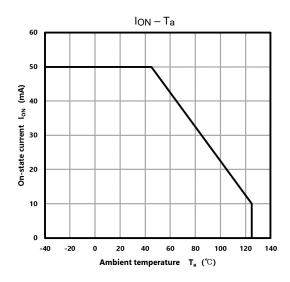


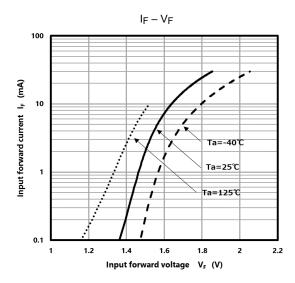


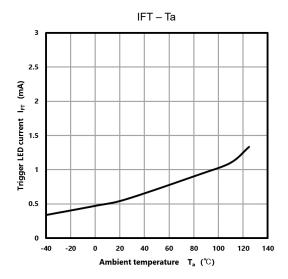


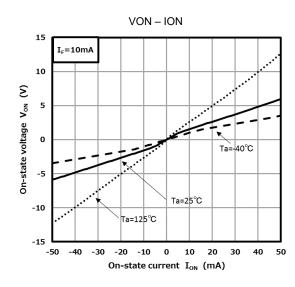
Characteristics curve (Note)

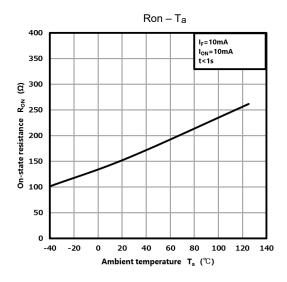


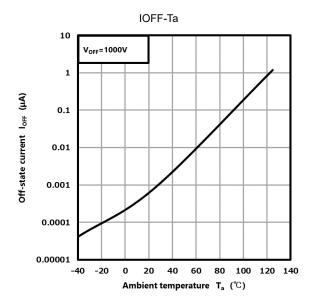


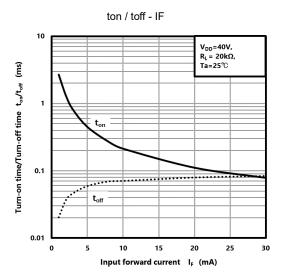


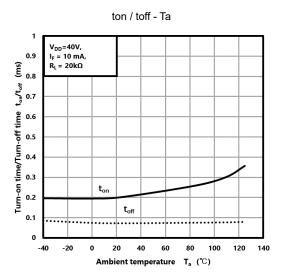












Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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